ESD, COG Dielectric, 25 – 250 VDC (Commercial & Automotive Grade)



Overview

The KEMET electrostatic discharge (ESD) rated commercial and automotive grade surface mount capacitors in COG dielectric are suited for a variety of applications where electrostatic discharge (ESD) events during assembly or operation could damage the capacitor or the circuit. These ESD rated capacitors provide the ability to design within a given ESD criteria per the human body model (HBM) AEC Q200–002 criteria. The KEMET automotive grade capacitors also meet the other demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

The COG dielectric features a 125°C maximum operating temperature and is considered "stable." The Electronics Industries Alliance (EIA) characterizes COG dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications, as well as those where Q and stability of capacitance characteristics are required. The COG dielectric exhibits no change in capacitance with respect to time and voltage, and boasts a negligible change in capacitance compared to its value at 25°C. Capacitance change is limited to ±30 ppm/°C from -55°C to +125°C.

Benefits

- AEC-Q200 automotive qualified
- ESD qualified per HBM AEC Q200-002
- Available in package size EIA 0402, 0603, 0805, 1206
- DC Voltage ratings of 25 V, 50 V, 63 V, 100 V, 200 V and 250 V
- Capacitance range from 1 nF to 100 nF
- -55°C to +125°C operating temperature range
- Lead (Pb)-free, RoHS and REACH compliant
- Available capacitance tolerances of ±1%, ±2%, ±5%, ±10%, and ±20%
- No piezoelectric noise
- Extremely low ESR and ESL
- · High thermal stability
- High ripple current capability
- Preferred capacitance solution at line frequencies and into the MHz range
- · No capacitance changes with respect to applied DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +125°C
- · No capacitance decay with time
- · Non-polar devices, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- Flexible Termination option available



Typical applications include: electrostatic discharge (ESD), integrated circuit (IC) protection, radio frequency (RF) filtering function, input and output automotive applications such as controllers, navigation systems, airbags and keyless systems.





Ordering Information

С	0603	С	103	J	3	G	E	С	AUTO
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ²	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ²	Packaging/ Grade (C-Spec)
	0402 0603 0805 1206	C = Standard X = Flexible Termination	Two significant digits and number of zeros	F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	3 = 25 5 = 50 M = 63 1 = 100 2 = 200 A = 250	G = COG	E = ESD	C = 100% Matte Sn	See "Packaging C-Spec Ordering Options Table"

¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details.

Table 1A - Capacitance Range/Selection Waterfall

		Case Size/ Series		C0402C C0603C C0805C							C1206C												
Capacitance	Cap Code	Rated Voltage (VDC)	25	50	63	100	25	50	63	100	200	25	50	63	100	200	250	25	50	63	100	200	250
		Voltage Code	3	5	М	1	3	5	М	1	2	3	5	М	1	2	A	3	5	М	1	2	A
		Cap Tolerance									ESD	Level	per A	VEC-C	200								
1.0 nF	102		4 kV	4 kV	4 kV	4 kV	6 kV	6 kV	6 kV	6 kV	6 kV	8 kV	8 kV	8 kV	8 kV	8 kV	8 kV	12 kV	12 kV	12 kV	12 kV	12 kV	12 kV
1.5 nF	152		6 kV	6 kV			8 kV	8 kV	8 kV	8 kV	8 kV	8 kV	8 kV	16 kV	16 kV	16 kV	16 kV	16 kV	16 kV				
2.2 nF	222		6 kV				12 kV	12 kV	12 kV	12 kV	12 kV	12 kV	12 kV	16 kV									
3.3 nF	332						16 kV	16 kV	16 kV	16 kV		16 kV											
4.7 nF	472	F = ±1%					16 kV	16 kV	16 kV	16 kV		25 kV											
6.8 nF	682	G = ±2%					25 kV	25 kV				25 kV											
10 nF	103	J = ±5%					25 kV					25 kV	25 kV	25 kV	25 kV			25 kV					
15 nF	153	K = ±10%					25 kV					25 kV	25 kV	25 kV	25 kV			25 kV					
22 nF	223	M = ±20%										25 kV	25 kV					25 kV					
33 nF	333											25 kV						25 kV	25 kV	25 kV	25 kV		
47 nF	473											25 kV						25 kV	25 kV	25 kV	25 kV		
68 nF	683																	25 kV	25 kV				
100 nF	104																	25 kV					

DC (Direct Contact Discharged) for Values $\leq 8kV$ AC (Air Discharched) for Values $\geq 12kV$

² Additional capacitance tolerance offerings and termination finish options may be available. Contact KEMET for details.Benefits (cont'd)



Packaging C-Spec Ordering Options Table

Packaging Type	Packaging/Grade Ordering Code (C-Spec)
Commerc	ial Grade ¹
Bulk Bag	Not required (blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	7081
13" Reel/Unmarked/2 mm pitch ²	7082
Automoti	ve Grade ³
7" Reel	AUTO
13" Reel/Unmarked	AUTO7411 (EIA 0603 and smaller case sizes) AUTO7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	3190
13" Reel/Unmarked/2 mm pitch²	3191

¹ Default packaging is "Bulk Bag." An ordering code C-Spec is not required for "Bulk Bag" packaging.

The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking."

² The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

³ Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L" x W") and thickness dimension. See "Chip Thickness/Tape & Reel Packaging Quantities" and "Tape & Reel Packaging Information."

³ For additional information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information."

³ All automotive packaging C-Špecs listed exclude the option to laser mark components. The option to laser mark is not available on these devices. For more information see "Capacitor Marking."



Automotive C-Spec Information

KEMET automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET OEM automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below.)

Product Change Notification (PCN)

The KEMET product change notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Notifica	tion Due To:	Days Prior To
C-Spec	Process/Product change	Obsolescence*	Implementation
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days minimum
AUT0	Yes (without approval)	Yes	90 days minimum

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design records and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

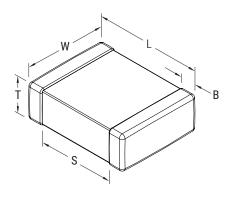
KEMET Automotive			PPAP Level		
C-Spec	1	2	3	4	5
KEMET assigned ¹	•	•	•	•	•
AUTO			0		

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part number specific PPAP available with customer information included.
- Product family PPAP only



Dimensions - Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
			Without Flexib	ole Termination			
0402	1005	1.00 (0.040) ±0.05 (0.002)	0.50 (0.020) ±0.05 (0.002)		0.30 (0.012) ±0.10 (0.004)	0.30 (0.012)	Solder reflow only
0603	1608	1.60 (0.063) ±0.15 (0.006)	0.80 (0.032) ±0.15 (0.006)	See Table 2 for	0.35 (0.014) ±0.15 (0.006)	0.70 (0.028)	
0805	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)	Thickness	0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder wave or Solder reflow
1206	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	N/A	Golder Fellow
			With Flexible	e Termination			
0603	1608	1.60 (0.063) ±0.17 (0.007)	0.80 (0.032) ±0.15 (0.006)		0.45 (0.018) ±0.15 (0.006)	0.58 (0.023)	
0805	2012	2.00 (0.079) ±0.30 (0.012)	1.25 (0.049) ±0.30 (0.012)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder wave or Solder reflow
1206	3216	3.30 (0.130) ±0.40 (0.016)	1.60 (0.063) ±0.35 (0.013)	0.60 (0.024) ±0.25 (0.010) N/A		N/A	



Qualification/Certification

Commercial grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0%
¹ Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)
² Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
³ Insulation Resistance (IR) Minimum Limit at 25°C	1,000 M Ω µF or 100 G Ω (Rated voltage applied for 120 ±5 seconds at 25°C)

¹ DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

Note: When measuring capacitance, it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as automatic level control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

Post Environmental Limits												
Dielectric	Rated DC Voltage	Capacitance	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance							
COG	All	All	0.5	0.3% or ±0.25 pf	10% of Initial limit							

² Capacitance and dissipation factor (DF) measured under the following conditions:

¹ MHz \pm 100 kHz and 1.0 \pm 0.2 V_{rms} if capacitance \leq 1,000 pF

¹ kHz \pm 50 Hz and 1.0 \pm 0.2 V_{rms} if capacitance > 1,000 pF

³ To obtain IR limit, divide M Ω - μ F value by the capacitance and compare to G Ω limit. Select the lower of the two limits.



Table 1B - Product Availability and Chip Thickness Waterfall - Standard Termination

		Case Size/ Series	C0402C				C0603C					C0805C						C1206C					
Capacitance	Cap Code	Rated Voltage (VDC)	25	50	63	100	25	50	63	100	200	25	50	63	100	200	250	25	50	63	100	200	250
		Voltage Code	3	5	М	1	3	5	М	1	2	3	5	М	1	2	A	3	5	М	1	2	A
		Cap Tolerance		Produ	ıct Av	ailab	ility a	nd Ch	ip Th	ickne	ss Co	des -	See	Packa	ging	Spec	s for (Chip T	hickr	iess [imen	sions	i
1.0 nF	102		ВВ	BB	BB	BB	CF	CF	CF	CF	CF	DD	DD	DD	DD	DD	DD	EQ	EQ	EQ	EQ	EQ	EQ
1.5 nF	152		BB	BB			CF	CF	CF	CF	CF	DR	DR	DR	DR	DR	DR	ER	ER	ER	ER	ER	ER
2.2 nF	222		BB				CF	CF	CF	CF	CF	DR	DR	DR	DR	DR	DR	ET	ET	ET	ET	ET	ET
3.3 nF	332						CF	CF	CF	CF		DR	DR	DR	DR	DR	DR	EQ	EQ	EQ	EQ	EQ	EQ
4.7 nF	472	F = ±1%					CF	CF	CF	CF		DD	DD	DD	DD	DD	DD	EQ	EQ	EQ	EQ	EQ	EQ
6.8 nF	682	G = ±2%					CF	CF				DG	DG	DG	DG	DG	DG	EQ	EQ	EQ	EQ	EQ	EQ
10 nF	103	J = ±5%					CF					DD	DD	DD	DD			ER	ER	ER	ER	ER	ER
15 nF	153	K = ±10%					CF					DG	DG	DG	DG			EF	EF	EF	EF	EF	EF
22 nF	223	M = ±20%										DF	DF					EH	EH	EH	EH	EH	EH
33 nF	333											DG						EF	EF	EF	EF		
47 nF	473											DG						EH	EH	EH	EH		
68 nF	683																	EH	EH				
100 nF	104																	EH					

Table 1C – Product Availability and Chip Thickness Waterfall – Flexible Termination

		Case Size/ Series		C	0603	C				C08	05C			C1206C							
Capacitance	Cap Code	Rated Voltage (VDC)	25	50	63	100	200	25	50	63	100	200	250	25	50	63	100	200	250		
		Voltage Code	3	5	М	1	2	3	5	М	1	2	A	3	5	М	1	2	A		
		Cap Tolerance	Prod	luct Av	/ailabi	ity and	d Chip	Thick	ness C	odes -	- See F	Packag	jing Sp	ecs fo	r Chip	Thick	ness [Dimens	sions		
1.0 nF	102		CJ	CJ	CJ	CJ	CJ	DD	DD	DD	DD	DD	DD	EQ	EQ	EQ	EQ	EQ	EQ		
1.5 nF	152		CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	ER	ER	ER	ER	ER	ER		
2.2 nF	222		CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	ET	ET	ET	ET	ET	ET		
3.3 nF	332		CJ	CJ	CJ	CJ		DR	DR	DR	DR	DR	DR	EQ	EQ	EQ	EQ	EQ	EQ		
4.7 nF	472	F = ±1%	CJ	CJ	CJ	CJ		DD	DD	DD	DD	DD	DD	EQ	EQ	EQ	EQ	EQ	EQ		
6.8 nF	682	G = ±2%	CJ	CJ				DG	DG	DG	DG	DG	DG	EQ	EQ	EQ	EQ	EQ	EQ		
10 nF	103	$J = \pm 5\%$	CJ					DD	DD	DD	DD			ER	ER	ER	ER	ER	ER		
15 nF	153	K = ±10%	CJ					DG	DG	DG	DG			EF	EF	EF	EF	EF	EF		
22 nF	223	M = ±20%	İ					DF	DF					EH	EH	EH	EH	EH	EH		
33 nF	333		ĺ					DG						EF	EF	EF	EF				
47 nF	473							DG						EH	EH	EH	EH				
68 nF	683													EH	EH						
100 nF	104													EH							



Table 2 - Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic (Quantity
Code	Size ¹	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
BB	0402	0.50 ± 0.05	10,000	50,000	0	0
CF	0603	0.80 ± 0.07	4,000	15,000	0	0
DN	0805	0.78 ± 0.10	4,000	15,000	0	0
DP	0805	0.90 ± 0.10	4,000	15,000	0	0
DF	0805	1.10 ± 0.10	0	0	2,500	10,000
DG	0805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	0	0	4,000	10,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
EE	1206	1.10 ± 0.10	0	0	2,500	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EH	1206	1.60 ± 0.20	0	0	2,000	8,000

Table 3 - Bulk Packaging Quantities

Dackac	ing Type	Loose Pa	ackaging						
Packay	ing Type	Bulk Bag (default)							
Packagi	ng C-Spec¹	N,	/A ²						
Cas	e Size	Packaging Quantities (pieces/unit packaging)						
EIA (in)	Metric (mm)	Minimum	Maximum						
0402	1005								
0603	1608								
0805	2012		50,000						
1206	3216								
1210	3225	1							
1808	4520								
1812	4532								
1825	4564		20,000						
2220	5650								
2225	5664								

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for automotive grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and automotive grade products.) The 15th through 22nd character positions of the ordering code should be left blank. All products ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.

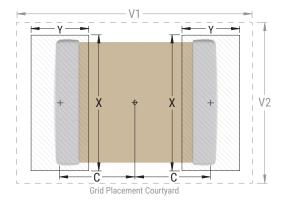


Table 4 - Land Pattern Design Recommendations per IPC-7351

EIA Size Code	Metric Size Code		Maxi	sity Lev mum (I otrusio)	Density Level B: Median (Nominal) Land Protrusion (mm)			Density Level C: Minimum (Least) Land Protrusion (mm)						
Code	Code	С	Y	X	V 1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2
	Without Flexible Termination															
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
						Witl	h Flexibl	e Termin	ation							
0603	1608	0.85	1.25	1.10	4.00	2.10	0.75	1.05	1.00	3.10	1.50	0.65	0.85	0.90	2.40	1.20
0805	2012	0.99	1.44	1.66	4.47	2.71	0.89	1.24	1.56	3.57	2.11	0.79	1.04	1.46	2.42	1.81
1206	3216	1.59	1.62	2.06	5.85	3.06	1.49	1.42	1.96	4.95	2.46	1.39	1.22	1.86	4.25	2.16

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).





Soldering Process

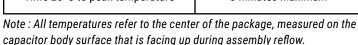
Recommended Soldering Technique

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile

The KEMET families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish				
r toille i eature	100% Matte Sn				
Preheat/Soak					
Temperature minimum (T _{Smin})	150°C				
Temperature maximum (T _{Smax})	200°C				
Time (t_s) from T_{smin} to T_{smax}	60 - 120 seconds				
Ramp-up rate $(T_L \text{ to } T_P)$	3°C/second maximum				
Liquidous temperature (T _L)	217°C				
Time above liquidous (t_L)	60 - 150 seconds				
Peak temperature (T _P)	260°C				
Time within 5°C of maximum peak temperature (t _p)	30 seconds maximum				
Ramp-down rate (T _p to T _L)	6°C/second maximum				
Time 25°C to peak temperature	8 minutes maximum				



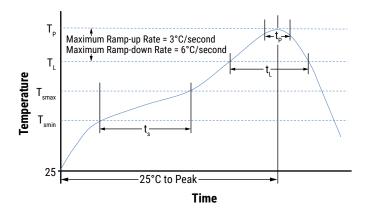




Table 5 - Performance & Reliability: Test Methods and Conditions

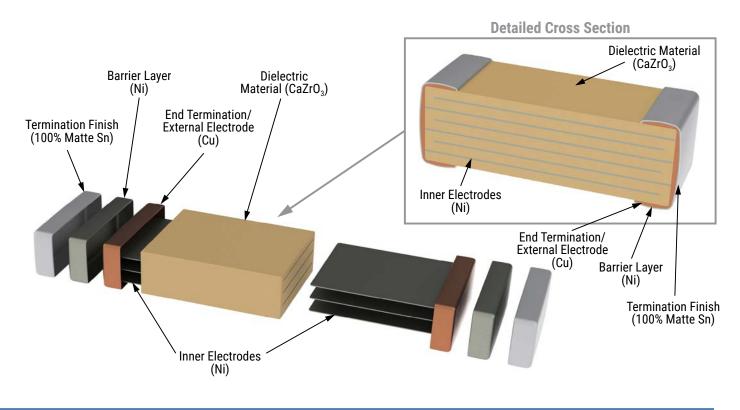
Stress	Reference	Test or Inspection Method			
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.			
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).			
		Magnification 50 X. Conditions:			
Coldorobility	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C			
Solderability	J-31D-002	b) Method B at 215°C, category 3			
		c) Method D at 260°C, category 3			
Temperature Cycling	JESD22 Method JA-104	1,000 Cycles (-55°C to +125°C). Measurement at 24 hours ±4 hours after test conclusion.			
D: 111 · 15	MIL-STD-202	Load humidity: 1,000 hours 85°C/85% RH and rated voltage. Add 100 K ohm resistor. Measurement at 24 hours ±4 hours after test conclusion.			
Biased Humidity	Method 103	Low volt humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours ±4 hours after test conclusion.			
Moisture Resistance MIL-STD-202 t = 24 hou Measurem		= 24 hours/cycle. Steps 7a and 7b not required. Measurement at 24 hours ±4 hours after test conclusion.			
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.			
High Temperature Life	MIL-STD-202 Method 108/EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.			
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.			
Vibration	MIL-STD-202 Method 204	5 g's for 20 minutes, 12 cycles each of 3 orientations. Note: use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz			
Mechanical Shock MIL-STD-202 Method 213 Figure 1 of Method 213,		Figure 1 of Method 213, Condition F.			
Resistance to Solvents MIL-STD-202 Method 215		Add aqueous wash chemical, OKEM Clean or equivalent.			

Storage and Handling

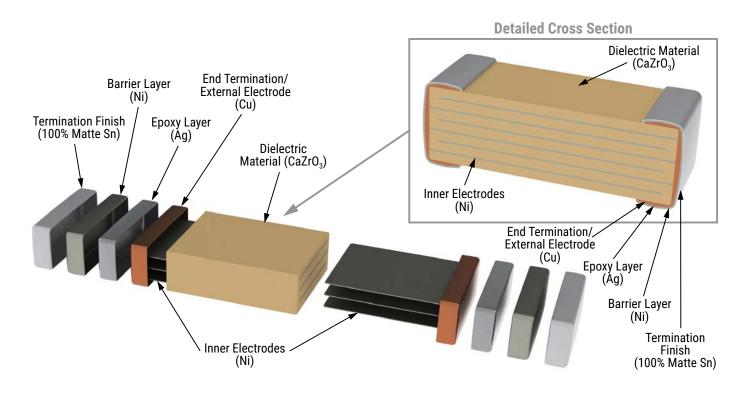
Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction – Standard Termination



Construction – Flexible Termination





Capacitor Marking (Optional)

Laser marking option is not available on:

- · COG, ultra stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with flexible termination option.
- · KPS commercial and automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

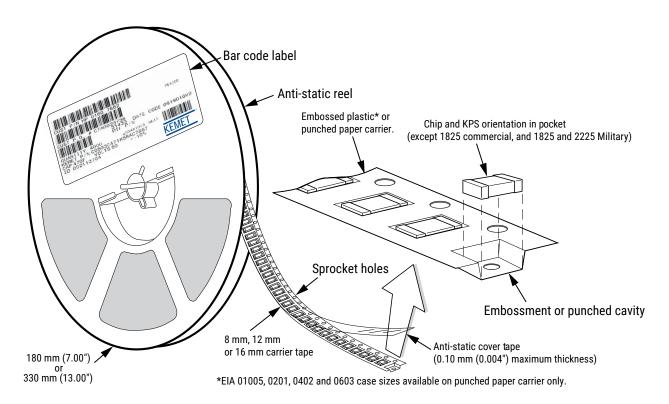


Table 6 - Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Tape	Embosse	d Plastic	Punched Paper		
EIA Case Size	Size	7" Reel	13" Reel	7" Reel	13" Reel	
	(W)*	Pitch	(P ₁)*	Pitch (P ₁)*		
01005 - 0402	8			2	2	
0603	8			2/4	2/4 /	
0805	8	4	4	4	4	
1206 - 1210	8	4	4	4	4	
1805 - 1808	12	4	4			
≥ 1812	12	8	8			
KPS 1210	12	8	8			
KPS 1812 and 2220	16	12	12			
Array 0612	8	4	4			

^{*}Refer to Figures 1 and 2 for W and P_1 carrier tape reference locations.

New 2 mm Pitch Reel Options*

	Packaging Ordering Code (C-Spec)	Packaging Type/Options
1	C-3190	Automotive grade 7" reel unmarked
١	C-3191	Automotive grade 13" reel unmarked
	C-7081	Commercial grade 7" reel unmarked
	C-7082	Commercial grade 13" reel unmarked

^{* 2} mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.

^{*}Refer to Tables 6 and 7 for tolerance specifications.



Figure 1 - Embossed (Plastic) Carrier Tape Dimensions

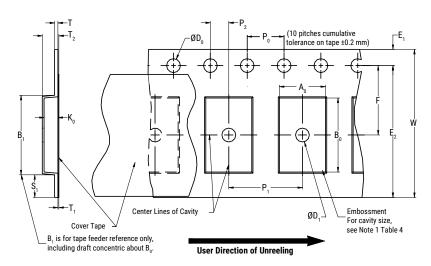


Table 7 - Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions – Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum	
8 mm		1.0 (0.039)		4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)			30 (1.181)		0.600 (0.024)	0.100 (0.004)	
16 mm		(0.059)								
	Variable Dimensions — Millimeters (Inches)									
Tape Size	Tape Size Pitch B ₁ Maximum E ₂ F P ₁ T ₂ W Maximum A ₀ , B ₀ & K ₀							& K ₀		
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)			
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Note 5		
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)			

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)
- 3. If S, < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by A_{o} , B_{o} and K_{o} shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes, and 10° maximum for 16 mm tapes (see Figure 3.)
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape, and to 1.0 mm maximum for 16 mm tape (see Figure 4.)
 - (e) for KPS product, A_0 and B_0 are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 - Punched (Paper) Carrier Tape Dimensions

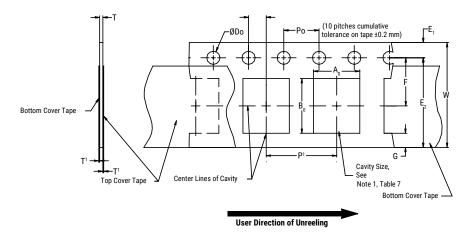


Table 8 - Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)										
Tape Size	D _o	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2			
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)			
	Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	$A_0^{}B_0^{}$			
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1			
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note I			

- 1. The cavity defined by A_{n} , B_{n} and T shall surround the component with sufficient clearance that:
 - a) the component does not protrude beyond either surface of the carrier tape.
 - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - c) rotation of the component is limited to 20° maximum (see Figure 3.)
 - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)
 - e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6.)



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 3 – Maximum Component Rotation

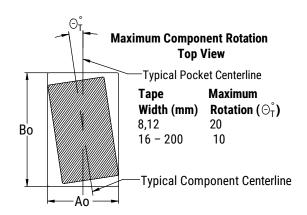


Figure 4 - Maximum Lateral Movement

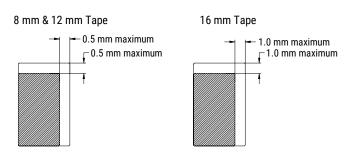


Figure 5 - Bending Radius

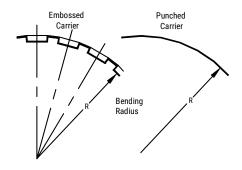
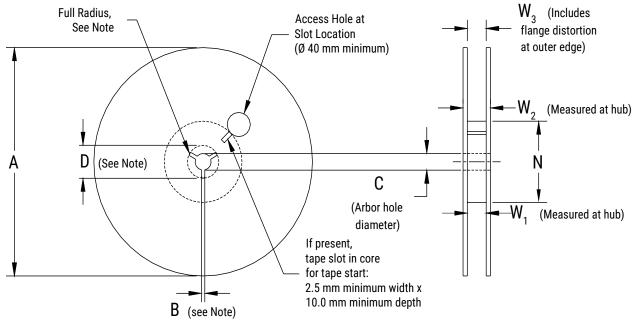




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 9 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	A	B Minimum	С	D Minimum					
8 mm	178 ±0.20								
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)					
16 mm	330 ±0.20 (13.000 ±0.008)	(***)	(,					
	Variable Dimensions — Millimeters (Inches)								
Tape Size	N Minimum	W_1	W ₂ Maximum	W ₃					
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)						
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference					
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)						



Figure 7 - Tape Leader & Trailer Dimensions

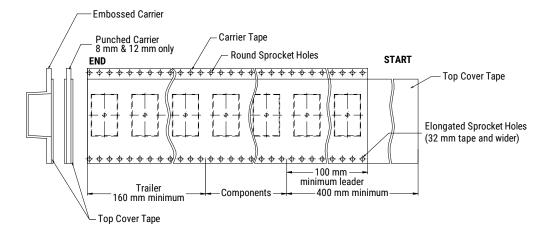
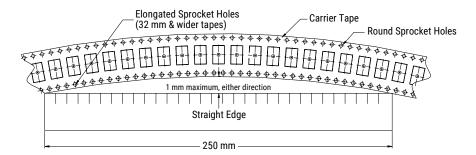


Figure 8 – Maximum Camber





KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

Disclaimer

YAGEO Corporation and its affiliates do not recommend the use of commercial or automotive grade products for high reliability applications or manned space flight.

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Multilayer Ceramic Capacitors MLCC - SMD/SMT category:

Click to view products by Kemet manufacturer:

Other Similar products are found below:

M39014/02-1218V M39014/02-1225V M39014/22-0631 D55342E07B523DR-T/R NCA1206X7R103K50TRPF NIN-FC2R7JTRF
NMC0201X5R474K4TRPF NMC0402NPO220J50TRPF NMC0402X5R105K6.3TRPF NMC0402X5R224K6.3TRPF
NMC0402X7R103J25TRPF NMC0402X7R392K50TRPF NMC0603NPO101F50TRPF NMC0603NPO20J50TRPF
NMC0603X5R475M6.3TRPF NMC0603X7R333K16TRPF NMC0805NPO270J50TRPF NMC0805NPO820J50TRPF
NMC0805X7R224K16TRPLPF NMC1206X7R102K50TRPF NMC1206X7R106K10TRPLPF C1608C0G2A221J C1608X7R1E334K
C2012C0G2A472J 2220J2K00562KXT CCR06CG153FSV CDR04BX104AKSR CDR33BX104AKUR CDR33BX683AKUS
CGA3E1X7R1C684K CL10C0R8BB8ANNC M55342H06B20G0R-T/R C1005X5R0G225M C2012X7R2E223K C3216C0G2J272J
D55342E07B35E7R-T/R CDR34BX563BKUS CDR34BX563BKWS NMC0402X7R562J25TRPF NMC0603NPO102J25TRPF
NMC1206X7R332K50TRPF NMC-P1206X7R104K250TRPLPF 726632-1 CGA6M3X7R1H225K CGA5L2X7R2A105K
CGA3E2X8R1H223K CDR33BX823AKUR\M500 CDR33BP132BJUR CDR35BX474AKUR\M500 CDR35BX104BKUR\M500